Page 1 of 2			
Attorney Bocket 1º: 01-019			Patent
FEB 1 2 2002 DECLARATION, I	POWER OF ATTORNEY,	, AND PETITION	
As the low named inventor, I hereby de	clare that:		
My residence, post office address and ci	tizenship are as stated below	next to my name.	
I believe I am the original, first, and sole joint inventor (if plural names are listed b is sought on the invention entitled "Meth Techniques Using Storage Device Snaps	elow) of the subject matter w od for the Acceleration and S	hich is claimed and for	or which a patent
	, oper		ENVEN
is attached hereto X was filed on November	19, 2001 as Application Ser	ial № 10/001,889.	GENVED 8 15 2002
(if applicable)		DEFUTY	OF PETITIONS A/C PATENTS ed specification
I hereby state that I have reviewed an including the claims, as amended by any		of the acove laciting	ed specification,
I acknowledge the duty to disclose infor accordance with Title 37, Code of Feder		the examination of th	is application in
I hereby claim foreign priority benefit application(s) for patent or inventor's ce application for patent or inventor's certification priority is claimed:	rtificate listed below and ha	we also identified be	low any foreign
PRIOR FOREIG	GN APPLICATION(S)		
·			Yes No
(Number)	(Country)	(Date Filed)	
			_Yes No
(Number)	(Country)	(Date Filed)	
I hereby claim the benefit under Title 35, below and, insofar as the subject matter of United States application in the manner 112, I acknowledge the duty to disclost Regulations, § 1.56(a), regarding events the national or PCT international filing of	of each of the claims of this approvided by the first paragrase material information as owhich occurred between the	pplication is not disclaph of Title 35, Unite defined in Title 37, 0	osed in the prior d States Code, § Code of Federal
(Application Serial Nº)	(Filing Dat	e)	(Status)

(Filing Date)

(Status)

(Application Serial Nº)

I hereby declare that all statements made of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint Ralph R. Veseli, Reg. 33,807; Sandeep Jaggi, Reg. 43,331; Peter P. Scott, Reg. 33,279; Timothy Croll, Reg. 36,771; Gary Goates, Reg. 35,159; Leo J. Peters, Reg. 33,562; Sean Patrick Suiter, Reg. 34,260; Kevin E. West, Reg. 43,983; William J. Breen, III, Reg. 45,313; Chad W. Swantz, Reg. 46,329; Walter J. Malinowski, Reg. 43,423 and Nathan T. Grebasch, Reg. 48,600, as my attorneys with full power of substitution and revocation, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith and before competent international authorities.

Please send all correspondence to: **Mark Salvatore Intellectual Property Law Department LSI Logic Corporation** M/S D-106 1551 McCarthy Boulevard Milpitas, CA 95035 (408) 433-7472



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PATENT TRADEMARK OFFICE

Wherefore, I pray that Letters Patent be granted to me for the invention or discovery described and claimed in the foregoing specification and claims, and I hereby subscribe my name to the foregoing specification and claims, declaration, power of attorney, and this petition.

First Inventor's Full Name:	William P.	<u>Delaney</u>		
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, ,				
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